



September 2025







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cecSum Market Activity Finance Strategy

Your contacts



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Chairman and Chief Executive Officer



José Hernandez Deputy General Manager



Evan Hingray
Administrative, Finance and HR
Director

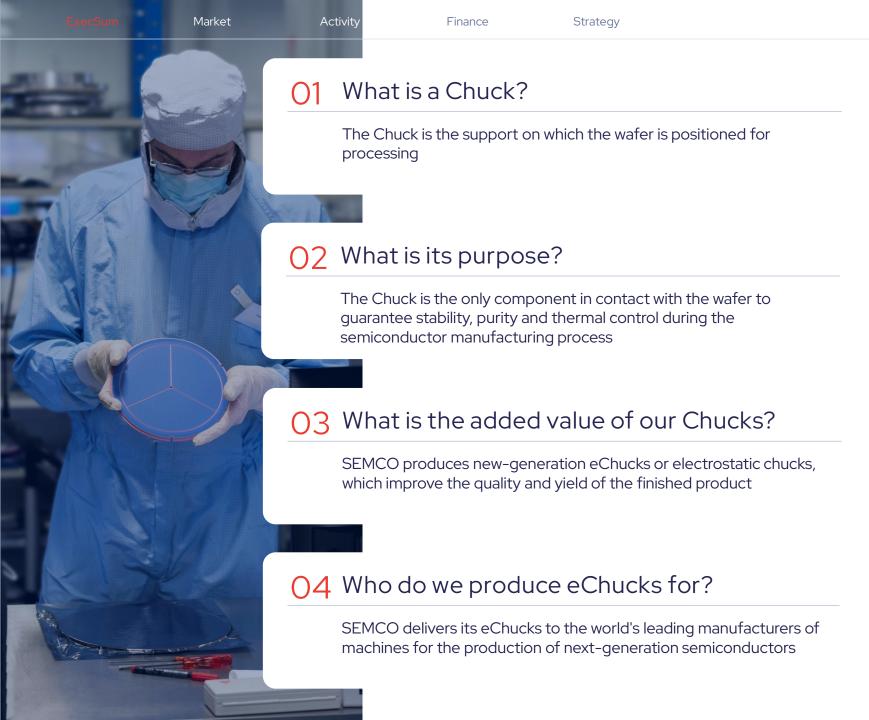
+35 years experience in industrial engineering

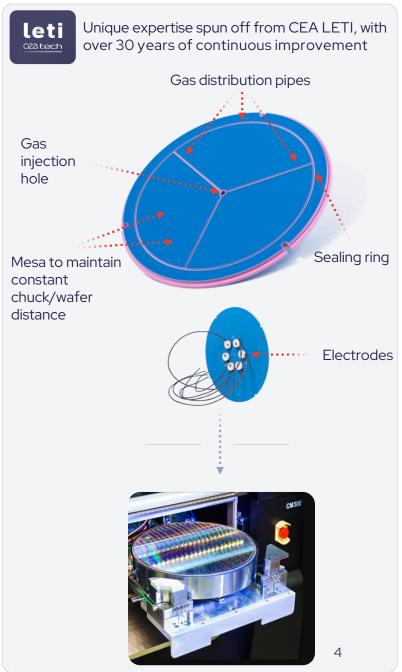
+30 years
experience in the semiconductor industry

+10 years
experience in Audit and the semiconductor industry

An experienced management team, visionary and determined to pursuing the growth trajectory







ExecSum Market Activity Finance Strategy

A high-tech company, pure player in the manufacturing of a strategic component for advanced semiconductors

$700 \, \text{m}^2$

2 ISO 7 and ISO 5 cleanrooms

56

Employees, 25% of engineers

€26.4 m

Sales 2024*

€16.6 m

Sales H1 2025**

21.4%

CAGR projection 2016-2025***

36.8%

EBIT margin 2024*

38.6%

EBIT margin H1 2025

*Pro forma information for 2024 and comparative information including: (1) the sale of "Gas Components" business, transferred to ECM Components on April 30, 2024, and (2) the sale of shares in SEMCO Smartech Suzhou, a Chinese subsidiary, to another ECM Group subsidiary.

^{***}Including the 2025 revenue target calculated at the average EUR/USD exchange rate of 1.0823 as of December 31, 2024.



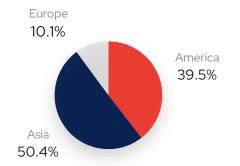


A 100% subsidiary of a family-owned group, world's leader in the manufacturing of equipment for materials processing and transformation



100%

Sales 2024 generated abroad*



^{**}Revenue calculated at the average EUR/USD exchange rate of 1.093 as of 30 June 2025

SEMCO Technologies serves the leading equipment manufacturers in the semiconductor industry...



...facing major technological innovation challenges of end markets

Miniaturization of chips: circuits more compact requiring greater temperature uniformity; reduced power consumption

Wafer densification: adding multiple layers to chips to increase capacity and efficiency (3D)

Reducing wafer contamination: guaranteeing maximum purity during manufacturing

Need for power components: to meet the demands of new technologies

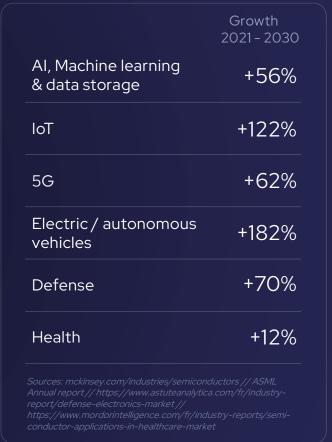
Growing need for higher yields and lower manufacturing costs: 300mm wafers



<mark>xecSum</mark> Market Activity Finance Strategy

New paradigm for the semiconductor industry, driven by the growth of new technologies





SEMCO Technologies benefits from the increasingly high investment needs of the sector



kecSum Market Activity Finance Strategy

A solid track record of profitable growth





^{*}Pro forma information 2024 (PF) and comparative information 2023 (IC) including: i) the sale of "Gas Components" and ii) the sale of shares in SEMCO Smartech (Suzhou) Co. Ltd, a Chinese subsidiary, to another ECM Group entity, both transactions having taken place in 2025.

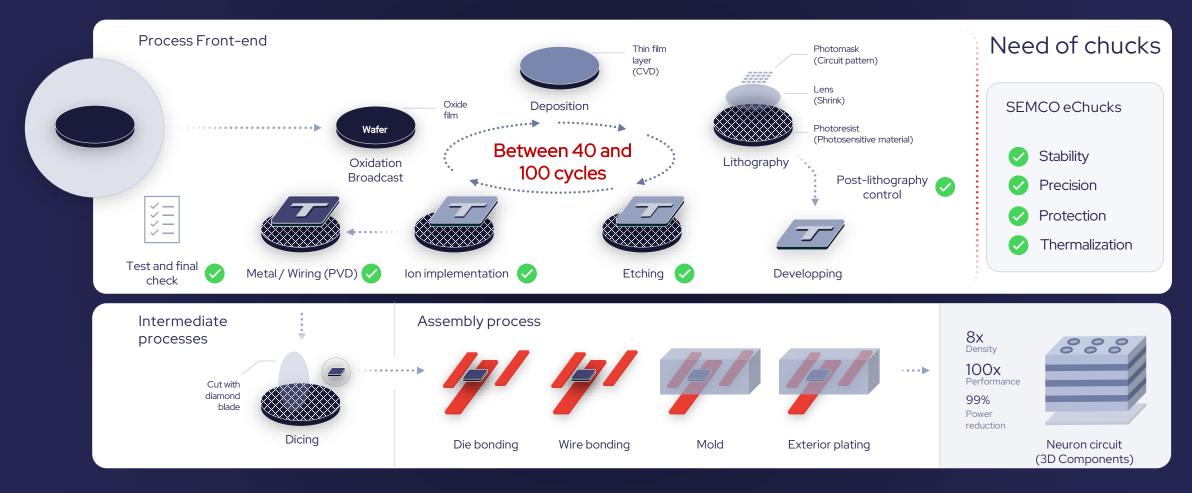
A strategic positioning that shields SEMCO Technologies from the cyclicality of the semiconductor market



^{**}Including the 2025 revenue target calculated at the average EUR/USD exchange rate of 1.0823 as of December 31, 2024.

xecSum Market <mark>Activity</mark> Finance Strategy

Front-end, the highest value-added stage in the semiconductor manufacturing process



SEMCO Technologies, a key partner at the heart of the value chain



SEMCO Technologies: the pure player in the design and production of electrostatic chucks

The electrostatic chuck, the only component in direct contact with the wafer in semiconductor manufacturing



The eChuck or electrostatic chuck: a disk equipped with electrodes for stable holding of silicon wafers.

Greater stability of the wafer	 Flat retention during semiconductor manufacturing processes Stable positioning without mechanical stress
Increase of purity	Optimum wafer handlingProcessing at very high or very low temperatures
Optimizing thermal control	Thermalization for uniform temperature control
Improvement quality and yields	 Stability and performance repeatability among the best on the market Productivity improvement

SEMCO's eChuck is the most advanced and complete solution for next-generation semiconductor manufacturing



xecSum Market <mark>Activity</mark> Finance Strategy

An integrated industrial model from design to manufacturing 4.0 Made in France

Montpellier production site



2 cleanrooms of 700 m²

ISO 5 and 7

- Complete range with high quality standards and custom designs to meet customers' needs
- Robotic welding line for pedestals
- Sourcing of raw materials dedicated to each customer

Manufacturing process

1 piece



150 processing steps

30 firing operations (1 day each)

+ 2,000 control points (effective traceability of raw materials)

Average manufacturing time 12 weeks



Current production capacity
>> 2,000 units per year

A state-of-the-art production process which guarantees solid barriers to entry



xecSum Market <mark>Activity</mark> Finance Strategy

A tailor-made innovation strategy based on a co-development model



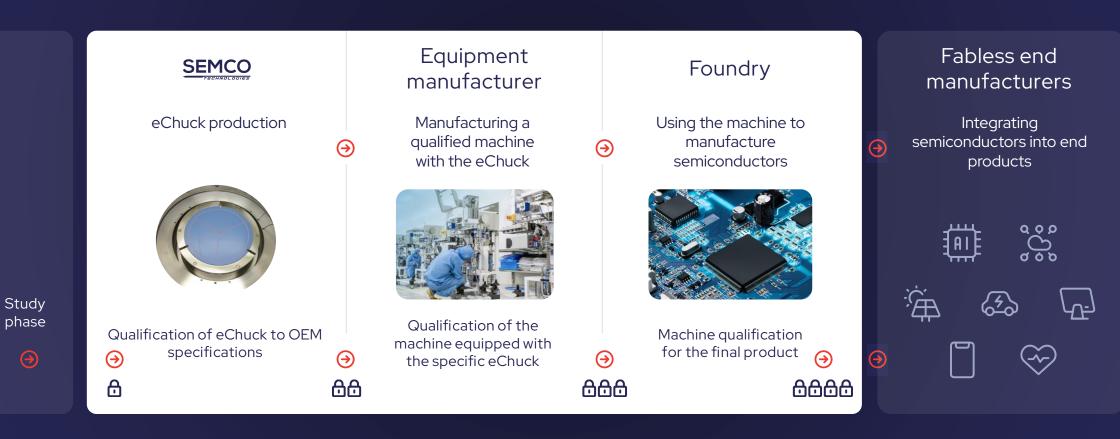
The eChuck qualifies the machine and the production process

- Continuous innovation cycle in collaboration with OEM customers
- Compliance with specifications and adaptation to technological needs
- Product design and prototyping
- Project co-development: eChucks design remains the exclusive property of SEMCO Technologies
- Design office with 8 employees, all of whom are bound by professional secrecy
- Once the machine is on the market, SEMCO co-develops the next generation with the customer, ensuring a continuous cycle of innovation

Know-how built on over 30 years' experience, self-financed and without capitalized R&D



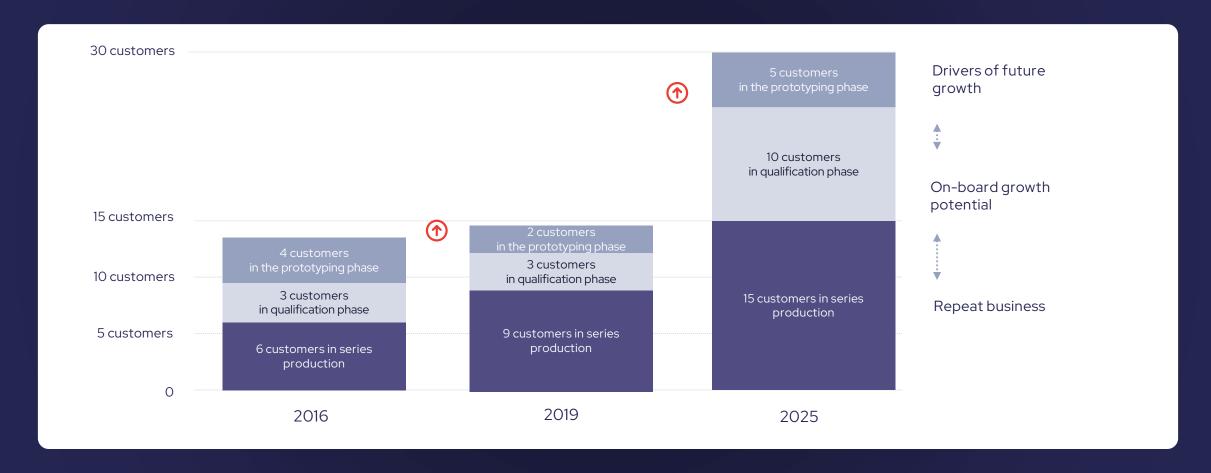
Once qualified, the eChuck is the strategic captive component in the semiconductor production process



Strong ramp-up in embedded volumes for more than 20 years



Strong commercial momentum driven by solid repeat business and growth drivers



A record customer portfolio with strong potential for incremental growth



xecSum Market Activity <mark>Finance</mark> Strategy

Key elements of the H1 2025¹ income statement

In thousands of €		H1 2025
Revenue ²		16,625
Gross margin		11,099
	% gross margin ratio	66.8%
Adjusted EBITDA		6,803
	% adjusted EBITDA gross margin	40.9%
EBIT		6,423
	% EBIT margin	38.6%
Consolidated net income		4,142
	% revenue	24.9%

Gross margin stands at €11.1m, i.e. 66.8% of revenue: reflecting the quality of the production process and rigorous management of purchasing costs

EBIT amounted to €6.4m, i.e. 38.6% of revenue: highlighting the high added value of SEMCO eChucks and excellent operational control

High net income of €4.1 million, representing nearly 25% of revenue



¹ Following the sale of the Gas Components business to ECM Components on 30 April 2024, there is no comparable basis for the 2024 half-year results...

 $^{^2\,\}text{Revenue}$ calculated at the average EUR/USD exchange rate of 1.093 as of 30 June 2025

Balance sheet as of 30 June 2025¹

In thousands of €	30.06.2025
Net intangible assets	475
Net tangible fixed assets	3 800
Net financial fixed assets	48
Fixed assets	4,322
Net inventories	7,685
Accounts receivable	10,850
Other receivables and accruals	2,615
Marketable securities	27
Availability	9,793
Current assets	30,970
TOTAL ASSETS	35,292

In thousands of euros	30.06.2025
Equity attributable to equity holders of the parent	14,613
Provisions	249
Financial liabilities	3,448
Trade accounts payable	10,340
Other payables and accruals	6,642
Payables	20,430
TOTAL LIABILITIES	35,292

Fixed assets at €4.3m including:

• €3.8m in property, plant and equipment directly linked to production

Iventories:

Moral obligation between SEMCO and its customers:

- Minimize disruption to our customers' customers
- Shorten the production cycle

Other liabilities:

€6.8m of which:

- €3.7m to ECM Group
- €1.7m of Corporate Income Tax



Following the sale of the Gas Components business to ECM Components on 30 April 2024, there is no comparable basis for the 2024 half-year results...

xecSum Market Activity <mark>Finance</mark> Strategy

A diversified and qualified Board of Directors to support growth strategy



Laurent Pelissier
Chairman and CEO, SEMCO
Technologies

Strategic, operational, management and foreign trade expertise



Marlène Pelissier
Co-Managing Director of LaMa,
President of ECM Group

Strategic, operational and management expertise, human resources management



José Hernandez Deputy General Manager

Technical, operational and management expertise



Geoff West
Executive Vice President
Purchasing,
STMicroelectronics

Operational and supply expertise, particularly in the semiconductor sector, financial and management expertise



Patricia Mavigner Executive Vice President, Thermador Groupe

Strategic, operational, management and financial expertise

2 censors:

- Maria Paublant,
 Chief Executive Officer of Garibaldi
 Participations
- Stephen Fargis,
 Director of Direct Large Cap
 Investments at Bpifrance
 Investissement



Expertise built on an experimented, structured team



General Manager
José HERNANDEZ

Lean Manager Advisor¹

Olivier PRIOUX



Financial Officer

Lilian TRAPANI +1 employee



Deputy General Manager

Laurent TERTRAIS

HR Manager

IT Manager

+1 employee



Sales Manager

Olivier SAUBIN

- +1 employee US Area
- +1 employee Taïwan Area¹
- +2 employees in Sales Administration



Engineering Manager

Charles Peroni

- +5 employees
- +R&D Manager: Smahane RAMI



Production Manager

Xavier Froment

+20 employees

Printing, Polishing, Bonding/Glassing



Quality Manager

Noëlie LIVET

+7 employees

Quality Ctrl, Meca/Elec/Visual/ Supplier, Method, Safety/ Environment, Clean Room Environment



- Supply Chain & Planning Manager
- Laurent TERTRAIS
- +Purchase Manager : Didier METZ
- +Logistic Manager: Delphine TAVERNIER
- +Planning: Estelle ADAMO



01

Industrial

Production ramp-up and ongoing investment in a 4.0 site

Automation of a new production line

- Processing capacity of up to 300 treatments per day (x3)
- Switch to continuous production, 7/7
- Further automation of industrial processes, including polishing, visual, mechanical and electrical control
- Prioritization of high value-added tasks, reduction of operational risks limiting particle generation and part handling

Improved production management

- MES system¹
- Reinforced traceability at various entry points in the production chain
- Smart real-time control

New international production facilities

- 300m² cleanroom in the United States
- Setting up a second cleanroom in China

Increased production and yields

Development strategy based on three pillars

02

Technological

Continue to supply the nextgeneration semiconductor industry 03

Commercial

Intensify international sales forces

Satisfy the demand for diversification of unit references.

Target acquisitions of new technological building blocks: new industrial processes, CVD market, etc.

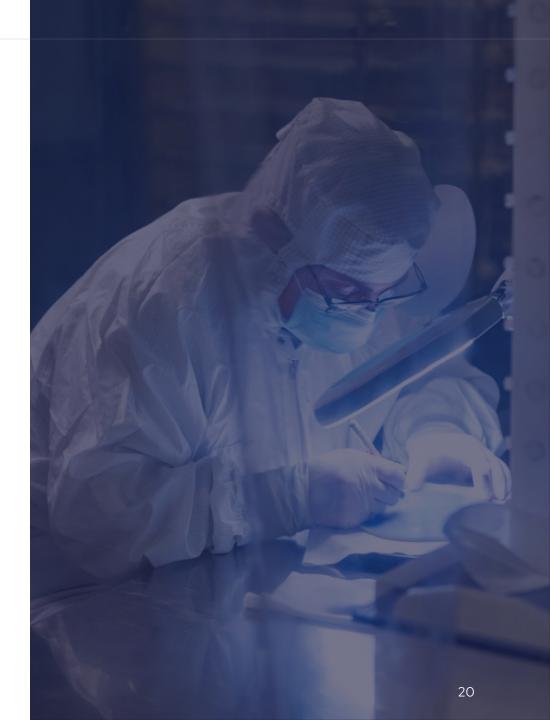
Developing new generations of eChucks: temperature limits,

Deploying sales power: implementing a pull-to-push strategy

Opening a subsidiary in China based on the US model

Strengthening leadership in strategic markets





Confirmation of all commercial, operational, and financial objectives

2025^{1}

Revenue of c.€33 m², 100% booked as of end April

EBIT margin of c. 38.5%

30% minimum distribution of net income³

2028

Revenue exceeding €55 m²

EBIT margin exceeding 40%

30% minimum distribution of net income³



³ Payment in 2026 for fiscal year 2025 / payment in 2029 for fiscal year 2028



¹Forecasts within the meaning of the Prospectus Regulation

²Target calculated at the average EUR/USD rate of 1.0823 on December 31, 2024.





ExecSum Market Activity Finance Strategy

The eChuck, the only component in contact with the wafer during the semiconductor manufacturing process



¹CVD: chemical vapor deposition ² PVD: physical vapor deposition

The eChuck ensures production efficiency: maintenance, temperature management, minimization of mechanical stress and maximization of purity



Unique technological features for compatibility with leading state-of-theart processes

Size	Compatible with substrates from 50 to 450mm diameter and more	
Temperature process	Temperature range -150°C to +650°C	
Technology	Coulombic: for Si and III-V wafers, compatible with non-conductive substrates such as sapphire, TSV, etc.	
Electrode type	Bipolarity, Multipolarity	
Custom design	Unique in the industry, customized chuck model for each customer, designed specifically for their applications to meet their technological performance requirements	
Complete system	eChuck supplied with stainless steel or titanium pedestal & connectors	



Unique expertise spun off from CEA LETI, with over 30 years of continuous improvement



 Θ

1 essential component at a marginal cost compared to the OEM's machine (<1%)

Direct validation with OEM technical departments (without validation by purchasing departments)

Technological differentiation underpinning solid pricing power



A top-tier clients portfolio, loyal and industry leaders





xecSum Market Activity <mark>Finance</mark> Strategy

A CSR strategy to decarbonize industry, energy production and transport

At the origin of tomorrow's technological and sustainable progress, SEMCO Technologies is committed to:











SEMCO Technologies, a key player in the transformation of industry to serve environmental sustainability and improve public health



Cash flow statement as of June 30, 2025

In thousands of €	30.06.2025
Total net profit of consolidated entities	4,142
Gross Cash Flow	4,275
Change in Working Capital related to operations (including provisions)	1,107
Net cash flow from operating activities	5,382
Acquisitions of Fixed Assets	-560
Disposals of Fixed Assets	1,556
Decrease in Other Financial Assets	1,120
Net cash flow from investing activities	2,116
Debt Repayments	-705
Repayment of Loan Related to the Sale of Suzhou	-1,639
Dividends Received/Paid from the Parent Company	-4,000
Net cash flow from financing activities	-6,345
Effect of exchange rate fluctuations	-121
Change in cash and cash equivalents	1,031
Opening Cash Balance	8,762
Closing Cash Balance	9,93

€1 million increase in cash flow:

Cash flow generated by first-half activity and the sale of assets not related to the eChuck business

Financial strength:

- Net cash: €6.3 million
- Equity increased to €14.6 million

The cash flow statement does not include the net amount raised as part of the capital increase carried out during the post-closing Initial Public Offering, amounting to approximately €3 million net.

